Welcome to [E-XFL.COM](#)**Understanding Embedded - FPGAs (Field Programmable Gate Array)**

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	6000
Number of Logic Elements/Cells	48000
Total RAM Bits	396288
Number of I/O	339
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-50e-6fn484i

Table 1-2. LatticeECP2M (Including “S-Series”) Family Selection

Device	ECP2M20	ECP2M35	ECP2M50	ECP2M70	ECP2M100
LUTs (K)	19	34	48	67	95
sysMEM Blocks (18kb)	66	114	225	246	288
Embedded Memory (Kbits)	1217	2101	4147	4534	5308
Distributed Memory (Kbits)	41	71	101	145	202
sysDSP Blocks	6	8	22	24	42
18x18 Multipliers	24	32	88	96	168
GPLL+SPLL+DLL	2+6+2	2+6+2	2+6+2	2+6+2	2+6+2
Maximum Available I/O	304	410	410	436	520
Packages and SERDES / I/O Combinations					
256-ball fpBGA (17 x 17 mm)	4 / 140	4 / 140			
484-ball fpBGA (23 x 23 mm)	4 / 304	4 / 303	4 / 270		
672-ball fpBGA (27 x 27 mm)		4 / 410	8 / 372		
900-ball fpBGA (31 x 31 mm)			8 / 410	16 / 416	16 / 416
1152-ball fpBGA (35 x 35 mm)				16 / 436	16 / 520

Introduction

The LatticeECP2/M family of FPGA devices is optimized to deliver high performance features such as advanced DSP blocks, high speed SERDES (LatticeECP2M family only) and high speed source synchronous interfaces in an economical FPGA fabric. This combination was achieved through advances in device architecture and the use of 90nm technology.

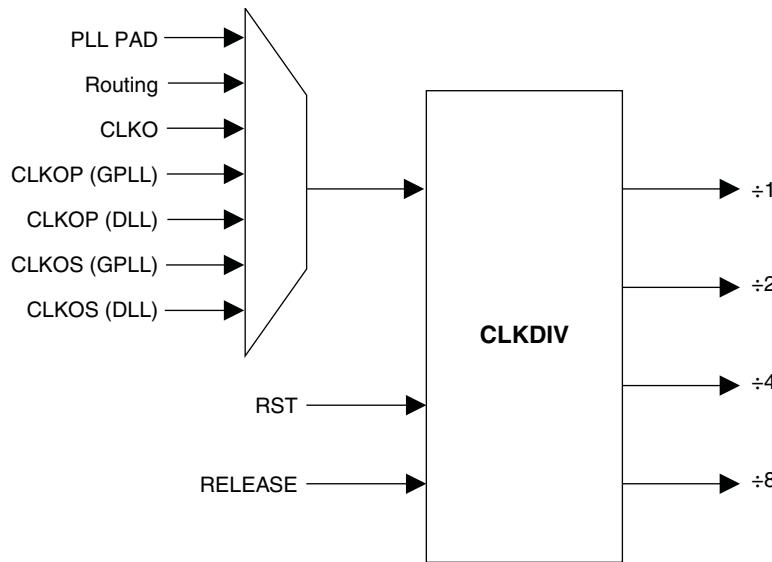
The LatticeECP2/M FPGA fabric is optimized with high performance and low cost in mind. The LatticeECP2/M devices include LUT-based logic, distributed and embedded memory, Phase Locked Loops (PLLs), Delay Locked Loops (DLLs), pre-engineered source synchronous I/O support, enhanced sysDSP blocks and advanced configuration support, including encryption (“S” versions only) and dual boot capabilities.

The LatticeECP2M device family features high speed SERDES with PCS. These high jitter tolerance and low transmission jitter SERDES with PCS blocks can be configured to support an array of popular data protocols including PCI Express, Ethernet (1GbE and SGMII), OBSAI and CPRI. Transmit Pre-emphasis and Receive Equalization settings make SERDES suitable for chip to chip and small form factor backplane applications.

Lattice Diamond® design software allows large complex designs to be efficiently implemented using the LatticeECP2/M FPGA family. Synthesis library support for LatticeECP2/M is available for popular logic synthesis tools. The Diamond software uses the synthesis tool output along with the constraints from its floor planning tools to place and route the design in the LatticeECP2/M device. The Diamond design tool extracts the timing from the routing and back-annotates it into the design for timing verification.

Lattice provides many pre-engineered IP (Intellectual Property) modules for the LatticeECP2/M family. By using these IP cores as standardized blocks, designers are free to concentrate on the unique aspects of their design, increasing their productivity.

Figure 2-9. Clock Divider Connections



Clock Distribution Network

LatticeECP2/M devices have eight quadrant-based primary clocks and eight flexible region-based secondary clocks/control signals. Two high performance edge clocks are available on each edge of the device to support high speed interfaces. These clock inputs are selected from external I/Os, the sysCLOCK PLLs, DLLs or routing. These clock inputs are fed throughout the chip via a clock distribution system.

Primary Clock Sources

LatticeECP2/M devices derive clocks from five primary sources: PLL (GPLL and SPLL) outputs, DLL outputs, CLK-DIV outputs, dedicated clock inputs and routing. LatticeECP2/M devices have two to eight sysCLOCK PLLs and two DLLs, located on the left and right sides of the device. There are eight dedicated clock inputs, two on each side of the device, with the exception of the LatticeECP2M 256-fpBGA package devices which have six dedicated clock inputs on the device. Figure 2-10 shows the primary clock sources.

MAC sysDSP Element

In this case, the two operands, A and B, are multiplied and the result is added with the previous accumulated value. This accumulated value is available at the output. The user can enable the input and pipeline registers, but the output register is always enabled. The output register is used to store the accumulated value. The Accumulators in the DSP blocks in the LatticeECP2/M family can be initialized dynamically. A registered overflow signal is also available. The overflow conditions are provided later in this document. Figure 2-24 shows the MAC sysDSP element.

Figure 2-24. MAC sysDSP

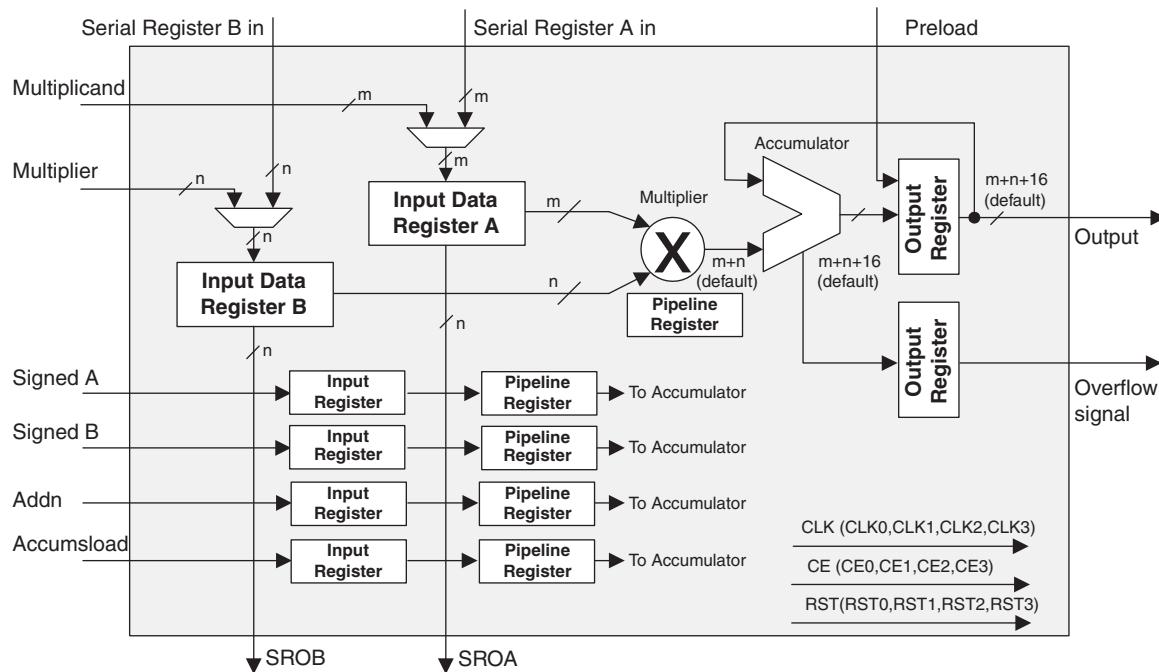
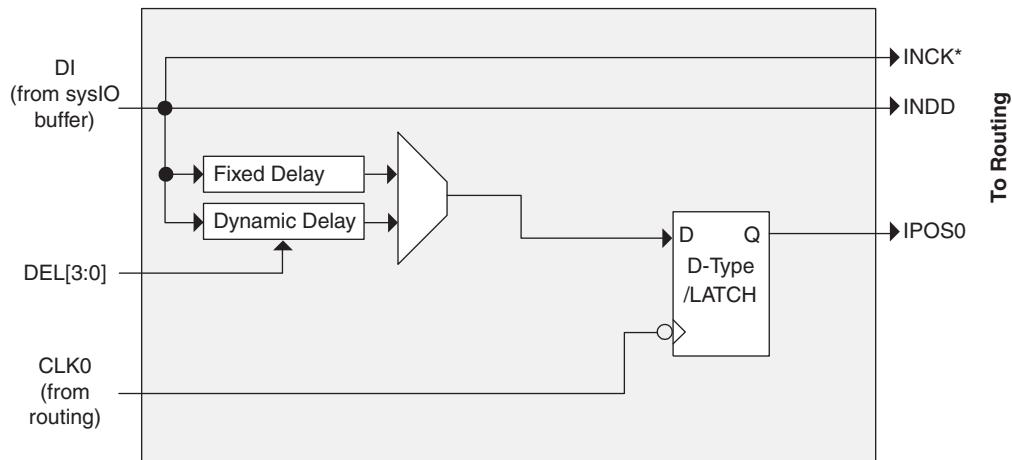


Figure 2-30. Input Register Block Top Edge



Note: Simplified version does not show CE and SET/RESET details.

*On selected blocks.

Output Register Block

The output register block provides the ability to register signals from the core of the device before they are passed to the sys/I/O buffers. The blocks on the PIOs on the left, right and bottom contain a register for SDR operation that is combined with an additional latch for DDR operation. Figure 2-31 shows the diagram of the Output Register Block for PIOs on the left, right and the bottom edges. Figure 2-32 shows the diagram of the Output Register Block for PIOs on the top edge of the device.

In SDR mode, ONEG0 feeds one of the flip-flops that then feeds the output. The flip-flop can be configured as a D-type or latch. In DDR mode, ONEG0 and OPOS0 are fed into registers on the positive edge of the clock. Then at the next clock cycle this registered OPOS0 is latched. A multiplexer running off the same clock selects the correct register for feeding to the output (D0).

By combining the output blocks of the complementary PIOs and sharing some registers from input blocks, a gearbox function can be implemented, that takes four data streams: ONEG0A, ONEG1A, ONEG1B and ONEG1B. Figure 2-32 shows the diagram using this gearbox function. For more information about this topic, please see information regarding additional documentation at the end of this data sheet.

LatticeECP2M Supply Current (Standby)^{1, 2, 3, 4}

Over Recommended Operating Conditions

Symbol	Parameter	Device	Typ. ⁵	Units
I_{CC}	Core Power Supply Current	ECP2M20	25	mA
		ECP2M35	50	mA
		ECP2M50	85	mA
		ECP2M70	100	mA
		ECP2M100	100	mA
I_{CCAUX}	Auxiliary Power Supply Current	ECP2M20	24	mA
		ECP2M35	24	mA
		ECP2M50	24	mA
		ECP2M70	24	mA
		ECP2M100	24	mA
I_{CCGPLL}	GPLL Power Supply Current (per GPLL)	All Devices	0.5	mA
I_{CCSPLL}	SPLL Power Supply Current (per SPLL)	All Devices	0.5	mA
I_{CCIO}	Bank Power Supply Current (Per Bank)	ECP2M20	2	mA
		ECP2M35	2	mA
		ECP2M50	2	mA
		ECP2M70	2	mA
		ECP2M100	2	mA
I_{CCJ}	V_{CCJ} Power Supply Current	All Devices	3	mA

1. For further information about supply current, please see the list of additional technical documentation at the end of this data sheet.
2. Assumes all outputs are tristated, all inputs are configured as LVCMSO and held at the V_{CCIO} or GND.
3. Frequency 0MHz.
4. Pattern represents a “blank” configuration data file.
5. $T_J = 25^\circ\text{C}$, power supplies at normal voltage.

LatticeECP2/M Family Timing Adders^{1, 2, 3} (Continued)

Over Recommended Operating Conditions

Buffer Type	Description	-7	-6	-5	Units
LVCMOS25_4mA	LVCMOS 2.5 4mA drive, slow slew rate	2.18	2.26	2.33	ns
LVCMOS25_8mA	LVCMOS 2.5 8mA drive, slow slew rate	2.19	2.35	2.51	ns
LVCMOS25_12mA	LVCMOS 2.5 12mA drive, slow slew rate	1.50	1.66	1.82	ns
LVCMOS25_16mA	LVCMOS 2.5 16mA drive, slow slew rate	1.60	1.59	1.58	ns
LVCMOS25_20mA	LVCMOS 2.5 20mA drive, slow slew rate	1.43	1.39	1.34	ns
LVCMOS18_4mA	LVCMOS 1.8 4mA drive, slow slew rate	2.22	2.27	2.32	ns
LVCMOS18_8mA	LVCMOS 1.8 8mA drive, slow slew rate	1.93	2.08	2.23	ns
LVCMOS18_12mA	LVCMOS 1.8 12mA drive, slow slew rate	1.43	1.51	1.58	ns
LVCMOS18_16mA	LVCMOS 1.8 16mA drive, slow slew rate	1.47	1.46	1.45	ns
LVCMOS15_4mA	LVCMOS 1.5 4mA drive, slow slew rate	2.32	2.38	2.43	ns
LVCMOS15_8mA	LVCMOS 1.5 8mA drive, slow slew rate	1.84	1.98	2.12	ns
LVCMOS12_2mA	LVCMOS 1.2 2mA drive, slow slew rate	2.52	2.63	2.74	ns
LVCMOS12_6mA	LVCMOS 1.2 6mA drive, slow slew rate	1.69	1.83	1.96	ns
PCI33	PCI33	0.04	0.04	0.04	ns

1. Timing Adders are characterized but not tested on every device.
2. LVCMOS timing measured with the load specified in Switching Test Condition table.
3. All other standards tested according to the appropriate specifications.
4. These timing adders are measured with the recommended resistor values.

Timing v.A 0.11

LatticeECP2/M sysCONFIG Port Timing Specifications

Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
sysCONFIG Byte Data Flow				
t_{SUCBDI}	Byte D[0:7] Setup Time to CCLK	7	—	ns
t_{HCBDI}	Byte D[0:7] Hold Time to CCLK	1	—	ns
t_{CODO}	CCLK to DOUT in Flowthrough Mode	—	12	ns
t_{SUCS}	CSN[0:1] Setup Time to CCLK	7	—	ns
t_{HCS}	CSN[0:1] Hold Time to CCLK	1	—	ns
t_{SUWD}	Write Signal Setup Time to CCLK	7	—	ns
t_{HWD}	Write Signal Hold Time to CCLK	1	—	ns
t_{DCB}	CCLK to BUSY Delay Time	—	12	ns
t_{CORD}	CCLK to Out for Read Data	—	12	ns
sysCONFIG Byte Slave Clocking				
t_{BSCH}	Byte Slave CCLK Minimum High Pulse	6	—	ns
t_{BSCL}	Byte Slave CCLK Minimum Low Pulse	9	—	ns
t_{BSCYC}	Byte Slave CCLK Cycle Time	15	—	ns
sysCONFIG Serial (Bit) Data Flow				
t_{SUSCDI}	DI Setup Time to CCLK Slave Mode	7	—	ns
t_{HSCDI}	DI Hold Time to CCLK Slave Mode	1	—	ns
t_{CODO}	CCLK to DOUT in Flowthrough Mode	—	12	ns
sysCONFIG Serial Slave Clocking				
t_{SSCH}	Serial Slave CCLK Minimum High Pulse	6	—	ns
t_{SSCL}	Serial Slave CCLK Minimum Low Pulse	6	—	ns
sysCONFIG POR, Initialization and Wake-up				
t_{ICFG}	Minimum Vcc to INITN High	—	28	ms
t_{VMC}	Time from t_{ICFG} to Valid Master CCLK	—	2	us
t_{PRGMRJ}	PROGRAMN Pin Pulse Rejection	—	8	ns
t_{PRGM}	PROGRAMN Low Time to Start Configuration	25	—	ns
t_{DINIT}	PROGRAMN High to INITN High Delay ¹	—	1.5	ms
$t_{DPPINIT}$	Delay Time from PROGRAMN Low to INITN Low	—	37	ns
$t_{DPPDONE}$	Delay Time from PROGRAMN Low to DONE Low	—	37	ns
t_{IODISS}	User I/O Disable from PROGRAMN Low	—	35	ns
t_{IOENSS}	User I/O Enabled Time from CCLK Edge During Wake-up Sequence	—	25	ns
t_{MWC}	Additional Wake Master Clock Signals after DONE Pin High	120	—	cycles
sysCONFIG SPI Port²				
t_{CFGX}	INITN High to CCLK Low	—	1	μs
t_{CSSPI}	INITN High to CSSPIN Low	—	2	us
t_{CSCCLK}	CCLK Low before CSSPIN Low	0	—	ns
t_{SOCDO}	CCLK Low to Output Valid	—	15	ns
t_{SOE}	CSSPIN[0:1] Active Setup Time	300	—	ns
t_{CSPID}	CSSPIN[0:1] Low to First CCLK Edge Setup Time	300+3cyc	600+6cyc	ns

LatticeECP2 Pin Information Summary, LFE2-50 and LFE2-70

Pin Type	LFE2-50		LFE2-70	
	484 fpBGA	672 fpBGA	672 fpBGA	900 fpBGA
Single Ended User I/O	339	500	500	583
Differential Pair User I/O	169	249	249	290
Configuration	TAP Pins	5	5	5
	Muxed Pins	14	14	14
	Dedicated Pins (Non TAP)	7	7	7
Non Configuration	Muxed Pins	68	79	89
	Dedicated Pins	3	3	3
VCC	16	20	20	26
VCCAUX	16	16	16	17
VCCPLL	4	4	2	4
VCCIO	Bank0	4	5	5
	Bank1	4	5	5
	Bank2	4	5	5
	Bank3	4	5	5
	Bank4	4	5	5
	Bank5	4	5	5
	Bank6	4	5	5
	Bank7	4	5	5
	Bank8	2	2	2
GND, GND0 to GND7	60	72	72	104
NC	0	3	5	101
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	50/25	67/33	67/33
	Bank1	46/23	66/33	66/33
	Bank2	38/19	56/28	56/28
	Bank3	22/11	48/24	48/24
	Bank4	46/23	62/31	62/31
	Bank5	46/23	68/34	68/34
	Bank6	40/20	64/32	64/32
	Bank7	37/18	55/27	55/27
	Bank8	14/7	14/7	14/7
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0
	Bank1 (Top Edge)	0	0	0
	Bank2 (Right Edge)	9	13	13
	Bank3 (Right Edge)	5	12	12
	Bank4 (Bottom Edge)	0	0	0
	Bank5 (Bottom Edge)	0	0	0
	Bank6 (Left Edge)	10	16	16
	Bank7 (Left Edge)	8	12	12
	Bank8 (Right Edge)	0	0	0

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

LFE2-6E/SE					LFE2-12E/12SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
136	PT6B	0		C	PT16B	0		C	
137	PT6A	0		T	PT16A	0		T	
138	GND	-			GND	-			
139	VCCIO0	0			VCCIO0	0			
140	PT4B	0		C	PT6B	0		C	
141	PT4A	0		T	PT6A	0		T	
142	VCCAUX	-			VCCAUX	-			
143	PT2B	0	VREF2_0	C	PT2B	0	VREF2_0	C	
144	PT2A	0	VREF1_0	T	PT2A	0	VREF1_0	T	

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for PLLs or GDLLs within the respective quadrant.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one-to-one connection with a package ball or pin.

LFE2-35E/SE and LFE2-50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-35E/SE					LFE2-50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
J22	PR29B	3	RDQ31	C (LVDS)*	PR48B	3	RDQ50	C (LVDS)*	
H22	PR29A	3	RDQ31	T (LVDS)*	PR48A	3	RDQ50	T (LVDS)*	
VCCIO	VCCIO3	3			VCCIO	3			
M20	PR28B	3	VREF2_3/RDQ31	C	PR47B	3	VREF2_3/RDQ50	C	
L21	PR28A	3	VREF1_3/RDQ31	T	PR47A	3	VREF1_3/RDQ50	T	
K21	PR27B	3	PCLKC3_0/RDQ31	C (LVDS)*	PR46B	3	PCLKC3_0/RDQ50	C (LVDS)*	
J21	PR27A	3	PCLKT3_0/RDQ31	T (LVDS)*	PR46A	3	PCLKT3_0/RDQ50	T (LVDS)*	
M18	PR25B	2	PCLKC2_0/RDQ22	C	PR44B	2	PCLKC2_0/RDQ41	C	
L17	PR25A	2	PCLKT2_0/RDQ22	T	PR44A	2	PCLKT2_0/RDQ41	T	
GNDIO	GNDIO2	-			GNDIO2	-			
L19	PR24B	2	RDQ22	C (LVDS)*	PR43B	2	RDQ41	C (LVDS)*	
L20	PR24A	2	RDQ22	T (LVDS)*	PR43A	2	RDQ41	T (LVDS)*	
L18	PR23B	2	RDQ22	C	PR42B	2	RDQ41	C	
K17	PR23A	2	RDQ22	T	PR42A	2	RDQ41	T	
VCCIO	VCCIO2	2			VCCIO	2			
K18	PR22B	2	RDQ22	C (LVDS)*	PR41B	2	RDQ41	C (LVDS)*	
K19	PR22A	2	RDQS22	T (LVDS)*	PR41A	2	RDQS41	T (LVDS)*	
G22	PR21B	2	RDQ22	C	PR40B	2	RDQ41	C	
GNDIO	GNDIO2	-			GNDIO2	-			
F22	PR21A	2	RDQ22	T	PR40A	2	RDQ41	T	
J17	PR20B	2	RDQ22	C (LVDS)*	PR39B	2	RDQ41	C (LVDS)*	
J18	PR20A	2	RDQ22	T (LVDS)*	PR39A	2	RDQ41	T (LVDS)*	
K20	PR19B	2	RDQ22	C	PR38B	2	RDQ41	C	
VCCIO	VCCIO2	2			VCCIO	2			
J19	PR19A	2	RDQ22	T	PR38A	2	RDQ41	T	
H21	PR18B	2	RDQ22	C (LVDS)*	PR37B	2	RDQ41	C (LVDS)*	
G21	PR18A	2	RDQ22	T (LVDS)*	PR37A	2	RDQ41	T (LVDS)*	
-	-	-			GNDIO2	-			
-	-	-			VCCIO	2			
H17	NC	-			PR26B	2	RUM0_SPLLC_FB_A/RDQ24	C	
H16	NC	-			PR26A	2	RUM0_SPLLT_FB_A/RDQ24	T	
H20	NC	-			PR25B	2	RUM0_SPLLC_IN_A/RDQ24	C	
H18	NC	-			PR25A	2	RUM0_SPLLT_IN_A/RDQ24	T	
-	-	-			GNDIO2	-			
-	-	-			VCCIO	2			
F21	PR17B	2	RDQ14	C	PR19B	2	RDQ16	C	
GNDIO	GNDIO2	-			GNDIO2	-			
E22	PR17A	2	RDQ14	T	PR19A	2	RDQ16	T	
D22	PR16B	2	RDQ14	C (LVDS)*	PR18B	2	RDQ16	C (LVDS)*	
E21	PR16A	2	RDQ14	T (LVDS)*	PR18A	2	RDQ16	T (LVDS)*	
G20	PR15B	2	RDQ14	C	PR17B	2	RDQ16	C	
VCCIO	VCCIO2	2			VCCIO	2			
F20	PR15A	2	RDQ14	T	PR17A	2	RDQ16	T	
H19	PR14B	2	RDQ14	C (LVDS)*	PR16B	2	RDQ16	C (LVDS)*	
G19	PR14A	2	RDQS14	T (LVDS)*	PR16A	2	RDQS16	T (LVDS)*	
GNDIO	GNDIO2	-			GNDIO2	-			

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
GND	GNDIO1	-			GNDIO1	-			
C15	PT45B	1		C	PT45B	1		C	
A15	PT45A	1		T	PT45A	1		T	
A13	PT44B	1		C	PT44B	1		C	
B13	PT44A	1		T	PT44A	1		T	
VCCIO	VCCIO1	1			VCCIO1	1			
H17	PT43B	1		C	PT43B	1		C	
H15	PT43A	1		T	PT43A	1		T	
D13	PT42B	1		C	PT42B	1		C	
C14	PT42A	1		T	PT42A	1		T	
GND	GNDIO1	-			GNDIO1	-			
G14	PT41B	1		C	PT41B	1		C	
E14	PT41A	1		T	PT41A	1		T	
A12	PT40B	1		C	PT40B	1		C	
B12	PT40A	1		T	PT40A	1		T	
VCCIO	VCCIO1	1			VCCIO1	1			
F14	PT39B	1	PCLKC1_0	C	PT39B	1	PCLKC1_0	C	
D14	PT39A	1	PCLKT1_0	T	PT39A	1	PCLKT1_0	T	
H16	XRES	1			XRES	1			
H14	PT37B	0	PCLKC0_0	C	PT37B	0	PCLKC0_0	C	
GND	GNDIO0	-			GNDIO0	-			
H13	PT37A	0	PCLKT0_0	T	PT37A	0	PCLKT0_0	T	
A11	PT36B	0		C	PT36B	0		C	
B11	PT36A	0		T	PT36A	0		T	
C13	PT35B	0		C	PT35B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
E13	PT35A	0		T	PT35A	0		T	
D12	PT34B	0		C	PT34B	0		C	
F13	PT34A	0		T	PT34A	0		T	
A10	PT33B	0		C	PT33B	0		C	
B10	PT33A	0		T	PT33A	0		T	
C12	PT32B	0		C	PT32B	0		C	
GND	GNDIO0	-			GNDIO0	-			
C10	PT32A	0		T	PT32A	0		T	
G13	PT31B	0		C	PT31B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
H12	PT31A	0		T	PT31A	0		T	
A9	PT30B	0		C	PT30B	0		C	
B9	PT30A	0		T	PT30A	0		T	
E12	PT29B	0		C	PT29B	0		C	
G12	PT29A	0		T	PT29A	0		T	
A8	PT28B	0		C	PT28B	0		C	
B8	PT28A	0		T	PT28A	0		T	
GND	GNDIO0	-			GNDIO0	-			
E11	PT27B	0		C	PT27B	0		C	
C9	PT27A	0		T	PT27A	0		T	

LFE2-70E/SE Logic Signal Connections: 900 fpBGA

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
VCCIO	VCCIO7	7		
F4	PL2A	7	VREF2_7	T (LVDS)*
F3	PL2B	7	VREF1_7	C (LVDS)*
H4	PL3A	7		T
G5	PL3B	7		C
GND	GNDIO7	-		
D2	PL4A	7		T (LVDS)*
D1	PL4B	7		C (LVDS)*
E2	PL5A	7		T
VCCIO	VCCIO7	7		
E1	PL5B	7		C
GND	GNDIO7	-		
VCCIO	VCCIO7	7		
F1	PL14A	7	LUM1_SPLL_IN_A/LDQ12	T (LVDS)*
F2	PL14B	7	LUM1_SPLLC_IN_A/LDQ12	C (LVDS)*
G1	PL15A	7	LUM1_SPLLFB_IN_A/LDQ12	T
G2	PL15B	7	LUM1_SPLLC_FB_A/LDQ12	C
GND	GNDIO7	-		
H8	PL18A	7	LDQ21	T
H6	PL18B	7	LDQ21	C
VCCIO	VCCIO7	7		
G4	PL19A	7	LDQ21	T (LVDS)*
G3	PL19B	7	LDQ21	C (LVDS)*
H7	PL20A	7	LDQ21	T
H5	PL20B	7	LDQ21	C
GND	GNDIO7	-		
H2	PL21A	7	LDQS21	T (LVDS)*
H1	PL21B	7	LDQ21	C (LVDS)*
J6	PL22A	7	LDQ21	T
VCCIO	VCCIO7	7		
J8	PL22B	7	LDQ21	C
J2	PL23A	7	LDQ21	T (LVDS)*
J1	PL23B	7	LDQ21	C (LVDS)*
J5	PL24A	7	LDQ21	T
GND	GNDIO7	-		
J7	PL24B	7	LDQ21	C
J4	PL25A	7	LDQ29	T (LVDS)*
J3	PL25B	7	LDQ29	C (LVDS)*
K6	PL26A	7	LDQ29	T
K8	PL26B	7	LDQ29	C
VCCIO	VCCIO7	7		
K2	PL27A	7	LDQ29	T (LVDS)*

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
AB6	PB17A	5	PCLKT5_0/BDQ15	T	PB35A	5	PCLKT5_0/BDQ33	T	
AB7	PB17B	5	PCLKC5_0/BDQ15	C	PB35B	5	PCLKC5_0/BDQ33	C	
VCCIO	VCCIO5	5			VCCIO5	5			
GNDIO	GNDIO5	-			GNDIO5	-			
AA8	PB22A	4	PCLKT4_0/BDQ24	T	PB40A	4	PCLKT4_0/BDQ42	T	
VCCIO	VCCIO4	4			VCCIO4	4			
AB8	PB22B	4	PCLKC4_0/BDQ24	C	PB40B	4	PCLKC4_0/BDQ42	C	
AA9	PB23A	4	VREF2_4/BDQ24	T	PB41A	4	VREF2_4/BDQ42	T	
Y9	PB23B	4	VREF1_4/BDQ24	C	PB41B	4	VREF1_4/BDQ42	C	
AB9	PB24A	4	BDQS24****	T	PB42A	4	BDQS42****	T	
GNDIO	GNDIO4	-			GNDIO4	-			
AB10	PB24B	4	BDQ24	C	PB42B	4	BDQ42	C	
AA10	PB25A	4	BDQ24	T	PB43A	4	BDQ42	T	
Y11	PB25B	4	BDQ24	C	PB43B	4	BDQ42	C	
VCCIO	VCCIO4	4			VCCIO4	4			
GNDIO	GNDIO4	-			GNDIO4	-			
V10	PB29A	4	BDQ33	T	PB47A	4	BDQ51	T	
U11	PB29B	4	BDQ33	C	PB47B	4	BDQ51	C	
V11	PB30A	4	BDQ33	T	PB48A	4	BDQ51	T	
W11	PB30B	4	BDQ33	C	PB48B	4	BDQ51	C	
AA11	PB31A	4	BDQ33	T	PB49A	4	BDQ51	T	
AB11	PB31B	4	BDQ33	C	PB49B	4	BDQ51	C	
VCCIO	VCCIO4	4			VCCIO4	4			
T11	PB32A	4	BDQ33	T	PB50A	4	BDQ51	T	
U12	PB32B	4	BDQ33	C	PB50B	4	BDQ51	C	
GNDIO	GNDIO4	-			GNDIO4	-			
AA12	PB33A	4	BDQS33	T	PB51A	4	BDQS51	T	
Y12	PB33B	4	BDQ33	C	PB51B	4	BDQ51	C	
V12	PB34A	4	BDQ33	T	PB52A	4	BDQ51	T	
W12	PB34B	4	BDQ33	C	PB52B	4	BDQ51	C	
AB12	PB35A	4	BDQ33	T	PB53A	4	BDQ51	T	
AA13	PB35B	4	BDQ33	C	PB53B	4	BDQ51	C	
VCCIO	VCCIO4	4			VCCIO4	4			
T12	PB36A	4	BDQ33	T	PB54A	4	BDQ51	T	
U13	PB36B	4	BDQ33	C	PB54B	4	BDQ51	C	
V13	PB37A	4	BDQ33	T	PB55A	4	BDQ51	T	
T13	PB37B	4	BDQ33	C	PB55B	4	BDQ51	C	
GNDIO	GNDIO4	-			GNDIO4	-			
AB13	PB38A	4	BDQ42	T	PB56A	4	BDQ60	T	
AB14	PB38B	4	BDQ42	C	PB56B	4	BDQ60	C	
U14	PB39A	4	BDQ42	T	PB57A	4	BDQ60	T	
T14	PB39B	4	BDQ42	C	PB57B	4	BDQ60	C	
AA14	PB40A	4	BDQ42	T	PB58A	4	BDQ60	T	
VCCIO	VCCIO4	4			VCCIO4	4			
Y14	PB40B	4	BDQ42	C	PB58B	4	BDQ60	C	
W14	PB41A	4	BDQ42	T	PB59A	4	BDQ60	T	
V14	PB41B	4	BDQ42	C	PB59B	4	BDQ60	C	
AB15	PB42A	4	BDQS42	T	PB60A	4	BDQS60	T	

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
GNDIO	GNDIO7	-			GNDIO7	-			
K5	PL23A	7	LDQS23	T (LVDS)*	PL27A	7	LDQS27	T*	
L5	PL23B	7	LDQ23	C (LVDS)*	PL27B	7	LDQ27	C*	
K4	PL24A	7	LDQ23	T	PL28A	7	LDQ27	T	
VCCIO	VCCIO7	7			VCCIO7	7			
L4	PL24B	7	LDQ23	C	PL28B	7	LDQ27	C	
K3	PL25A	7	LDQ23	T (LVDS)*	PL29A	7	LDQ27	T*	
L3	PL25B	7	LDQ23	C (LVDS)*	PL29B	7	LDQ27	C*	
J1	PL26A	7	LDQ23	T	PL30A	7	LDQ27	T	
GNDIO	GNDIO7	-			GNDIO7	-			
K2	PL26B	7	LDQ23	C	PL30B	7	LDQ27	C	
K1	PL28A	7	LUM1_SPLLTT_IN_A/LDQ32	T (LVDS)*	PL32A	7	LUM3_SPLLTT_IN_A/LDQ36	T*	
L1	PL28B	7	LUM1_SPLLC_IN_A/LDQ32	C (LVDS)*	PL32B	7	LUM3_SPLLC_IN_A/LDQ36	C*	
K8	PL29A	7	LUM1_SPLLTT_FB_A/LDQ32	T	PL33A	7	LUM3_SPLLTT_FB_A/LDQ36	T	
M5	PL29B	7	LUM1_SPLLC_FB_A/LDQ32	C	PL33B	7	LUM3_SPLLC_FB_A/LDQ36	C	
VCCIO	VCCIO7	7			VCCIO7	7			
M4	PL30A	7	LDQ32	T (LVDS)*	PL34A	7	LDQ36	T*	
M3	PL30B	7	LDQ32	C (LVDS)*	PL34B	7	LDQ36	C*	
L8	PL31A	7	LDQ32	T	PL35A	7	LDQ36	T	
M6	PL31B	7	LDQ32	C	PL35B	7	LDQ36	C	
GNDIO	GNDIO7	-			GNDIO7	-			
M1	PL32A	7	LDQS32	T (LVDS)*	PL36A	7	LDQS36	T*	
N1	PL32B	7	LDQ32	C (LVDS)*	PL36B	7	LDQ36	C*	
N3	PL33A	7	LDQ32	T	PL37A	7	LDQ36	T	
VCCIO	VCCIO7	7			VCCIO7	7			
N2	PL33B	7	LDQ32	C	PL37B	7	LDQ36	C	
N5	PL34A	7	LDQ32	T (LVDS)*	PL38A	7	LDQ36	T*	
N4	PL34B	7	LDQ32	C (LVDS)*	PL38B	7	LDQ36	C*	
M7	PL35A	7	PCLKT7_0/LDQ32	T	PL39A	7	PCLKT7_0/LDQ36	T	
GNDIO	GNDIO7	-			GNDIO7	-			
M8	PL35B	7	PCLKC7_0/LDQ32	C	PL39B	7	PCLKC7_0/LDQ36	C	
P3	PL37A	6	PCLKT6_0	T (LVDS)*	PL41A	6	PCLKT6_0	T*	
P2	PL37B	6	PCLKC6_0	C (LVDS)*	PL41B	6	PCLKC6_0	C*	
P5	PL38A	6	VREF2_6	T	PL42A	6	VREF2_6	T	
N6	PL38B	6	VREF1_6	C	PL42B	6	VREF1_6	C	
P4	PL39A	6		T (LVDS)*	PL43A	6		T*	
VCCIO	VCCIO6	6			VCCIO6	6			
R3	PL39B	6		C (LVDS)*	PL43B	6		C*	
P6	PL40A	6		T	PL44A	6		T	
N7	NC	-			PL44B	6		C	
P1	PL41A	6	LLM2_SPLLTT_IN_A	T (LVDS)*	PL45A	6	LLM3_SPLLTT_IN_A	T*	
GNDIO	GNDIO6	-			GNDIO6	-			
R1	PL41B	6	LLM2_SPLLC_IN_A	C (LVDS)*	PL45B	6	LLM3_SPLLC_IN_A	C*	
N8	PL42A	6	LLM2_SPLLTT_FB_A	T	PL46A	6	LLM3_SPLLTT_FB_A	T	
R5	PL42B	6	LLM2_SPLLC_FB_A	C	PL46B	6	LLM3_SPLLC_FB_A	C	
VCCIO	VCCIO6	6			VCCIO6	6			
T3	PL44A	6	LDQ48	T (LVDS)*	PL48A	6	LDQ52	T*	
T4	PL44B	6	LDQ48	C (LVDS)*	PL48B	6	LDQ52	C*	

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
L5	PL23A	7	LDQ27	T (LVDS)*	PL33A	7	LDQ37	T (LVDS)*	
L4	PL23B	7	LDQ27	C (LVDS)*	PL33B	7	LDQ37	C (LVDS)*	
N9	PL24A	7	LDQ27	T	PL34A	7	LDQ37	T	
N7	PL24B	7	LDQ27	C	PL34B	7	LDQ37	C	
K2	PL25A	7	LDQ27	T (LVDS)*	PL35A	7	LDQ37	T (LVDS)*	
K1	PL25B	7	LDQ27	C (LVDS)*	PL35B	7	LDQ37	C (LVDS)*	
P9	PL26A	7	LDQ27	T	PL36A	7	LDQ37	T	
P7	PL26B	7	LDQ27	C	PL36B	7	LDQ37	C	
GNDIO	GNDIO7	-			GNDIO7	-			
M6	PL27A	7	LDQS27	T (LVDS)*	PL37A	7	LDQS37	T (LVDS)*	
M5	PL27B	7	LDQ27	C (LVDS)*	PL37B	7	LDQ37	C (LVDS)*	
N5	PL28A	7	LDQ27	T	PL38A	7	LDQ37	T	
N6	PL28B	7	LDQ27	C	PL38B	7	LDQ37	C	
M4	PL29A	7	LDQ27	T (LVDS)*	PL39A	7	LDQ37	T (LVDS)*	
M3	PL29B	7	LDQ27	C (LVDS)*	PL39B	7	LDQ37	C (LVDS)*	
P6	PL30A	7	LDQ27	T	PL40A	7	LDQ37	T	
GNDIO	GNDIO7	-			GNDIO7	-			
P8	PL30B	7	LDQ27	C	PL40B	7	LDQ37	C	
L3	PL32A	7	LUM3_SPLLTT_IN_A/LDQ36	T (LVDS)*	PL42A	7	LUM3_SPLLTT_IN_A/LDQ46	T (LVDS)*	
L2	PL32B	7	LUM3_SPLLC_IN_A/LDQ36	C (LVDS)*	PL42B	7	LUM3_SPLLC_IN_A/LDQ46	C (LVDS)*	
P5	PL33A	7	LUM3_SPLLTT_FB_A/LDQ36	T	PL43A	7	LUM3_SPLLTT_FB_A/LDQ46	T	
P4	PL33B	7	LUM3_SPLLC_FB_A/LDQ36	C	PL43B	7	LUM3_SPLLC_FB_A/LDQ46	C	
L1	PL34A	7	LDQ36	T (LVDS)*	PL44A	7	LDQ46	T (LVDS)*	
M2	PL34B	7	LDQ36	C (LVDS)*	PL44B	7	LDQ46	C (LVDS)*	
R5	PL35A	7	LDQ36	T	PL45A	7	LDQ46	T	
R4	PL35B	7	LDQ36	C	PL45B	7	LDQ46	C	
GNDIO	GNDIO7	-			GNDIO7	-			
M1	PL36A	7	LDQS36	T (LVDS)*	PL46A	7	LDQS46	T (LVDS)*	
N2	PL36B	7	LDQ36	C (LVDS)*	PL46B	7	LDQ46	C (LVDS)*	
R8	PL37A	7	LDQ36	T	PL47A	7	LDQ46	T	
T9	PL37B	7	LDQ36	C	PL47B	7	LDQ46	C	
P3	PL38A	7	LDQ36	T (LVDS)*	PL48A	7	LDQ46	T (LVDS)*	
P2	PL38B	7	LDQ36	C (LVDS)*	PL48B	7	LDQ46	C (LVDS)*	
N1	PL39A	7	PCLKT7_0/LDQ36	T	PL49A	7	PCLKT7_0/LDQ46	T	
GNDIO	GNDIO7	-			GNDIO7	-			
P1	PL39B	7	PCLKC7_0/LDQ36	C	PL49B	7	PCLKC7_0/LDQ46	C	
T5	PL41A	6	PCLKT6_0	T (LVDS)*	PL51A	6	PCLKT6_0/LDQ55	T (LVDS)*	
T4	PL41B	6	PCLKC6_0	C (LVDS)*	PL51B	6	PCLKC6_0/LDQ55	C (LVDS)*	
U7	PL42A	6	VREF2_6	T	PL52A	6	VREF2_6/LDQ55	T	
T8	PL42B	6	VREF1_6	C	PL52B	6	VREF1_6/LDQ55	C	
R3	PL43A	6		T (LVDS)*	PL53A	6	LDQ55	T (LVDS)*	
VCCIO	VCCIO6	6			VCCIO6	6			
R2	PL43B	6		C (LVDS)*	PL53B	6	LDQ55	C (LVDS)*	
R1	PL44A	6		T	PL54A	6	LDQ55	T	
T1	PL44B	6		C	PL54B	6	LDQ55	C	
GNDIO	GNDIO6	-			GNDIO6	-			
-	-	-			VCCIO6	6			
T3	PL45A	6	LLM3_SPLLTT_IN_A	T (LVDS)*	PL57A	6	LLM3_SPLLTT_IN_A/LDQ55	T (LVDS)*	

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
U7	PL60A	6	VREF2_6/LDQ63	T
T8	PL60B	6	VREF1_6/LDQ63	C
R3	PL61A	6	LDQ63	T (LVDS)*
VCCIO	VCCIO6	6		
R2	PL61B	6	LDQ63	C (LVDS)*
R1	PL62A	6	LDQ63	T
T1	PL62B	6	LDQ63	C
GNDIO	GNDIO6	-		
VCCIO	VCCIO6	6		
T3	PL65A	6	LLM4_SPLLTT_IN_A/LDQ63	T (LVDS)*
T2	PL65B	6	LLM4_SPLLC_IN_A/LDQ63	C (LVDS)*
U9	PL66A	6	LLM4_SPLLTT_FB_A/LDQ63	T
U8	PL66B	6	LLM4_SPLLC_FB_A/LDQ63	C
GNDIO	GNDIO6	-		
U5	PL68A	6	LDQ72	T (LVDS)*
U4	PL68B	6	LDQ72	C (LVDS)*
V9	PL69A	6	LDQ72	T
V7	PL69B	6	LDQ72	C
VCCIO	VCCIO6	6		
U3	PL70A	6	LDQ72	T (LVDS)*
U2	PL70B	6	LDQ72	C (LVDS)*
V8	PL71A	6	LDQ72	T
U6	PL71B	6	LDQ72	C
GNDIO	GNDIO6	-		
U1	PL72A	6	LDQS72	T (LVDS)*
V2	PL72B	6	LDQ72	C (LVDS)*
V5	PL73A	6	LDQ72	T
VCCIO	VCCIO6	6		
V6	PL73B	6	LDQ72	C
V1	PL74A	6	LDQ72	T (LVDS)*
W1	PL74B	6	LDQ72	C (LVDS)*
W5	PL75A	6	LDQ72	T
GNDIO	GNDIO6	-		
W6	PL75B	6	LDQ72	C
W3	PL77A	6	LDQ81	T (LVDS)*
W4	PL77B	6	LDQ81	C (LVDS)*
W2	PL78A	6	LDQ81	T
Y4	PL78B	6	LDQ81	C
Y1	PL79A	6	LDQ81	T (LVDS)*
VCCIO	VCCIO6	6		
Y2	PL79B	6	LDQ81	C (LVDS)*
Y5	PL80A	6	LDQ81	T
Y6	PL80B	6	LDQ81	C

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
M10	VCCIO7	7		
M7	VCCIO7	7		
N10	VCCIO7	7		
N3	VCCIO7	7		
P10	VCCIO7	7		
R6	VCCIO7	7		
AA25	VCCIO8	8		
AD28	VCCIO8	8		
AA10	VCCAUX	-		
AA11	VCCAUX	-		
AA20	VCCAUX	-		
AA21	VCCAUX	-		
K10	VCCAUX	-		
K11	VCCAUX	-		
K20	VCCAUX	-		
K21	VCCAUX	-		
L10	VCCAUX	-		
L11	VCCAUX	-		
L20	VCCAUX	-		
L21	VCCAUX	-		
Y10	VCCAUX	-		
Y11	VCCAUX	-		
Y20	VCCAUX	-		
Y21	VCCAUX	-		
A1	GND	-		
A13	GND	-		
A18	GND	-		
A24	GND	-		
A30	GND	-		
A7	GND	-		
AA14	GND	-		
AA15	GND	-		
AA16	GND	-		
AA17	GND	-		
AA24	GND	-		
AA27	GND	-		
AA4	GND	-		
AB24	GND	-		
AB7	GND	-		
AD12	GND	-		
AD19	GND	-		
AD27	GND	-		
AE22	GND	-		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AK20	PB66B	4	BDQ69	C	PB75B	4	BDQ78	C
AN22	PB67A	4	BDQ69	T	PB76A	4	BDQ78	T
AL21	PB67B	4	BDQ69	C	PB76B	4	BDQ78	C
VCCIO	VCCIO4	4			VCCIO4	4		
GNDIO	GNDIO4	-			GNDIO4	-		
AH19	PB69A	4	BDQS69	T	PB78A	4	BDQS78	T
AJ20	PB69B	4	BDQ69	C	PB78B	4	BDQ78	C
AD20	PB71A	4	BDQ69	T	PB80A	4	BDQ78	T
AF20	PB71B	4	BDQ69	C	PB80B	4	BDQ78	C
VCCIO	VCCIO4	4			VCCIO4	4		
AJ19	PB72A	4	BDQ69	T	PB81A	4	BDQ78	T
AH20	PB72B	4	BDQ69	C	PB81B	4	BDQ78	C
AE20	PB73A	4	BDQ69	T	PB82A	4	BDQ78	T
AG20	PB73B	4	BDQ69	C	PB82B	4	BDQ78	C
GNDIO	GNDIO4	-			GNDIO4	-		
AH22	NC	-			PB89A	4	BDQ87	T
-	-	-			VCCIO4	4		
AH21	NC	-			PB89B	4	BDQ87	C
AG22	NC	-			PB90A	4	BDQ87	T
AG21	NC	-			PB90B	4	BDQ87	C
-	-	-			GNDIO4	-		
AM22	PB74A	4	BDQ78	T	PB92A	4	BDQ96	T
AL22	PB74B	4	BDQ78	C	PB92B	4	BDQ96	C
VCCIO	VCCIO4	4			VCCIO4	4		
AP23	PB77A	4	BDQ78	T	PB95A	4	BDQ96	T
AN23	PB77B	4	BDQ78	C	PB95B	4	BDQ96	C
GNDIO	GNDIO4	-			GNDIO4	-		
AM24	PB78A	4	BDQS78	T	PB96A	4	BDQS96	T
AL24	PB78B	4	BDQ78	C	PB96B	4	BDQ96	C
AK22	PB79A	4	BDQ78	T	PB97A	4	BDQ96	T
AJ22	PB79B	4	BDQ78	C	PB97B	4	BDQ96	C
AL23	PB80A	4	BDQ78	T	PB98A	4	BDQ96	T
AK23	PB80B	4	BDQ78	C	PB98B	4	BDQ96	C
VCCIO	VCCIO4	4			VCCIO4	4		
AJ23	PB81A	4	BDQ78	T	PB99A	4	BDQ96	T
AH23	PB81B	4	BDQ78	C	PB99B	4	BDQ96	C
GNDIO	GNDIO4	-			GNDIO4	-		
AL28	LRC_SQ_VCCRX3	13			LRC_SQ_VCCRX3	13		
AM26	LRC_SQ_HDINP3	13		T	LRC_SQ_HDINP3	13		T
AN26	LRC_SQ_VCCIB3	13			LRC_SQ_VCCIB3	13		
AM27	LRC_SQ_HDINN3	13		C	LRC_SQ_HDINN3	13		C
AN27	LRC_SQ_VCCTX3	13			LRC_SQ_VCCTX3	13		
AP26	LRC_SQ_HDOUTP3	13		T	LRC_SQ_HDOUTP3	13		T
AL26	LRC_SQ_VCCOB3	13			LRC_SQ_VCCOB3	13		
AP27	LRC_SQ_HDOUTN3	13		C	LRC_SQ_HDOUTN3	13		C
AN28	LRC_SQ_VCCTX2	13			LRC_SQ_VCCTX2	13		
AP28	LRC_SQ_HDOUTN2	13		C	LRC_SQ_HDOUTN2	13		C
AK28	LRC_SQ_VCCOB2	13			LRC_SQ_VCCOB2	13		
AP29	LRC_SQ_HDOUTP2	13		T	LRC_SQ_HDOUTP2	13		T

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
K11	NC	-			NC	-		
K12	NC	-			NC	-		
K13	NC	-			NC	-		
K23	NC	-			NC	-		
K24	NC	-			NC	-		
K25	NC	-			NC	-		
K26	NC	-			NC	-		
L11	NC	-			NC	-		
L12	NC	-			NC	-		
L13	NC	-			NC	-		
L14	NC	-			NC	-		
L21	NC	-			NC	-		
L22	NC	-			NC	-		
L23	NC	-			NC	-		
L24	NC	-			NC	-		
L25	NC	-			NC	-		
L26	NC	-			NC	-		
M11	NC	-			NC	-		
M24	NC	-			NC	-		
M25	NC	-			NC	-		
M6	NC	-			NC	-		
M8	NC	-			NC	-		
N10	NC	-			NC	-		
N11	NC	-			NC	-		
P10	NC	-			NC	-		
P25	NC	-			NC	-		
P26	NC	-			NC	-		
R9	NC	-			NC	-		
T11	NC	-			NC	-		
U11	NC	-			NC	-		
W11	NC	-			NC	-		
Y10	NC	-			NC	-		
Y11	NC	-			NC	-		
R15	VCCPLL	-			VCCPLL	-		
R20	VCCPLL	-			VCCPLL	-		
Y15	VCCPLL	-			VCCPLL	-		
Y20	VCCPLL	-			VCCPLL	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLS or GDLLs within the respective quadrant.

*** For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated pins for the higher density devices (ECP2M50, ECP2M70, and ECP2M100).

****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LatticeECP2M Standard Series Devices, Lead-Free Packaging

Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20E-5FN484C	304	1.2V	-5	Lead-Free fpBGA	484	COM	20
LFE2M20E-6FN484C	304	1.2V	-6	Lead-Free fpBGA	484	COM	20
LFE2M20E-7FN484C	304	1.2V	-7	Lead-Free fpBGA	484	COM	20
LFE2M20E-5FN256C	140	1.2V	-5	Lead-Free fpBGA	256	COM	20
LFE2M20E-6FN256C	140	1.2V	-6	Lead-Free fpBGA	256	COM	20
LFE2M20E-7FN256C	140	1.2V	-7	Lead-Free fpBGA	256	COM	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35E-5FN672C	410	1.2V	-5	Lead-Free fpBGA	672	COM	35
LFE2M35E-6FN672C	410	1.2V	-6	Lead-Free fpBGA	672	COM	35
LFE2M35E-7FN672C	410	1.2V	-7	Lead-Free fpBGA	672	COM	35
LFE2M35E-5FN484C	303	1.2V	-5	Lead-Free fpBGA	484	COM	35
LFE2M35E-6FN484C	303	1.2V	-6	Lead-Free fpBGA	484	COM	35
LFE2M35E-7FN484C	303	1.2V	-7	Lead-Free fpBGA	484	COM	35
LFE2M35E-5FN256C	140	1.2V	-5	Lead-Free fpBGA	256	COM	35
LFE2M35E-6FN256C	140	1.2V	-6	Lead-Free fpBGA	256	COM	35
LFE2M35E-7FN256C	140	1.2V	-7	Lead-Free fpBGA	256	COM	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50E-5FN900C	410	1.2V	-5	Lead-Free fpBGA	900	COM	50
LFE2M50E-6FN900C	410	1.2V	-6	Lead-Free fpBGA	900	COM	50
LFE2M50E-7FN900C	410	1.2V	-7	Lead-Free fpBGA	900	COM	50
LFE2M50E-5FN672C	372	1.2V	-5	Lead-Free fpBGA	672	COM	50
LFE2M50E-6FN672C	372	1.2V	-6	Lead-Free fpBGA	672	COM	50
LFE2M50E-7FN672C	372	1.2V	-7	Lead-Free fpBGA	672	COM	50
LFE2M50E-5FN484C	270	1.2V	-5	Lead-Free fpBGA	484	COM	50
LFE2M50E-6FN484C	270	1.2V	-6	Lead-Free fpBGA	484	COM	50
LFE2M50E-7FN484C	270	1.2V	-7	Lead-Free fpBGA	484	COM	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70E-5FN1152C	436	1.2V	-5	Lead-Free fpBGA	1152	COM	70
LFE2M70E-6FN1152C	436	1.2V	-6	Lead-Free fpBGA	1152	COM	70
LFE2M70E-7FN1152C	436	1.2V	-7	Lead-Free fpBGA	1152	COM	70
LFE2M70E-5FN900C	416	1.2V	-5	Lead-Free fpBGA	900	COM	70
LFE2M70E-6FN900C	416	1.2V	-6	Lead-Free fpBGA	900	COM	70
LFE2M70E-7FN900C	416	1.2V	-7	Lead-Free fpBGA	900	COM	70